NSBC114EPDXV6T1, NSBC114EPDXV6T5

Preferred Devices

Dual Bias Resistor Transistors

NPN and PNP Silicon Surface Mount Transistors with Monolithic Bias Resistor Network

The BRT (Bias Resistor Transistor) contains a single transistor with a monolithic bias network consisting of two resistors; a series base resistor and a base−emitter resistor. These digital transistors are designed to replace a single device and its external resistor bias network. The BRT eliminates these individual components by integrating them into a single device. In the NSBC114EPDXV6T1 series, two complementary BRT devices are housed in the SOT−563 package which is ideal for low power surface mount applications where board space is at a premium.

- Simplifies Circuit Design
- Reduces Board Space
- Reduces Component Count
- Available in 8 mm, 7 inch Tape and Reel
- Lead Free Solder Plating

MAXIMUM RATINGS (T_A = 25°C unless otherwise noted, common for Q_1 and Q_2, − minus sign for Q_1 (PNP) omitted)

Rating	Symbol	Value	Unit
Collector-Base Voltage	V_{CBO}	50	Vdc
Collector-Emitter Voltage	V_{CEO}	50	Vdc
Collector Current	I_C	100	mAdc

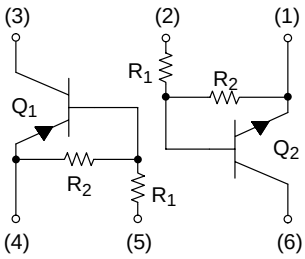
THERMAL CHARACTERISTICS

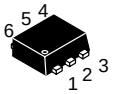
Characteristic (One Junction Heated)	Symbol	Max	Unit
Total Device Dissipation T_A = 25°C Derate above 25°C	P_D	357 (Note 1) 2.9 (Note 1)	mW mW/°C
Thermal Resistance Junction-to-Ambient	$R_{\theta JA}$	350 (Note 1)	°C/W
Characteristic (Both Junctions Heated)	**Symbol**	**Max**	**Unit**
Total Device Dissipation T_A = 25°C Derate above 25°C	P_D	500 (Note 1) 4.0 (Note 1)	mW mW/°C
Thermal Resistance Junction-to-Ambient	$R_{\theta JA}$	250 (Note 1)	°C/W
Junction and Storage Temperature	T_J, T_{stg}	−55 to +150	°C

1. FR−4 @ Minimum Pad

ON Semiconductor®

http://onsemi.com





SOT−563
CASE 463A
PLASTIC

MARKING DIAGRAM

xx = Specific Device Code (see table on page 2)
D = Date Code

ORDERING INFORMATION

Device	Package	Shipping
NSBC114EPDXV6T1	SOT−563	4 mm pitch 4000/Tape & Reel
NSBC114EPDXV6T5	SOT−563	2 mm pitch 8000/Tape & Reel

DEVICE MARKING INFORMATION

See specific marking information in the device marking table on page 2 of this data sheet.

Preferred devices are recommended choices for future use and best overall value.

DEVICE MARKING AND RESISTOR VALUES

Device	Package	Marking	R1 (kΩ)	R2 (kΩ)
NSBC114EPDXV6T1	SOT−563	11	10	10
NSBC124EPDXV6T1	SOT−563	12	22	22
NSBC144EPDXV6T1	SOT−563	13	47	47
NSBC114YPDXV6T1	SOT−563	14	10	47
NSBC114TPDXV6T1 (Note 2)	SOT−563	15	10	∞
NSBC143TPDXV6T1 (Note 2)	SOT−563	16	4.7	∞
NSBC113EPDXV6T1 (Note 2)	SOT−563	30	1.0	1.0
NSBC123EPDXV6T1 (Note 2)	SOT−563	31	2.2	2.2
NSBC143EPDXV6T1 (Note 2)	SOT−563	32	4.7	4.7
NSBC143ZPDXV6T1 (Note 2)	SOT−563	33	4.7	47
NSBC124XPDXV6T1 (Note 2)	SOT−563	34	22	47
NSBC123JPDXV6T1 (Note 2)	SOT−563	35	2.2	47

ELECTRICAL CHARACTERISTICS

(T_A = 25°C unless otherwise noted, common for Q_1 and Q_2, − minus sign for Q_1 (PNP) omitted)

Characteristic		Symbol	Min	Typ	Max	Unit
OFF CHARACTERISTICS						
Collector-Base Cutoff Current (V_{CB} = 50 V, I_E = 0)		I_{CBO}	−	−	100	nAdc
Collector-Emitter Cutoff Current (V_{CE} = 50 V, I_B = 0)		I_{CEO}	−	−	500	nAdc
Emitter-Base Cutoff Current (V_{EB} = 6.0 V, I_C = 0)	NSBC114EPDXV6T1	I_{EBO}	−	−	0.5	mAdc
	NSBC124EPDXV6T1		−	−	0.2	
	NSBC144EPDXV6T1		−	−	0.1	
	NSBC114YPDXV6T1		−	−	0.2	
	NSBC114TPDXV6T1		−	−	0.9	
	NSBC143TPDXV6T1		−	−	1.9	
	NSBC113EPDXV6T1		−	−	4.3	
	NSBC123EPDXV6T1		−	−	2.3	
	NSBC143EPDXV6T1		−	−	1.5	
	NSBC143ZPDXV6T1		−	−	0.18	
	NSBC124XPDXV6T1		−	−	0.13	
	NSBC123JPDXV6T1		−	−	0.2	
Collector-Base Breakdown Voltage (I_C = 10 μA, I_E = 0)		$V_{(BR)CBO}$	50	−	−	Vdc
Collector-Emitter Breakdown Voltage (Note 3) (I_C = 2.0 mA, I_B = 0)		$V_{(BR)CEO}$	50	−	−	Vdc
ON CHARACTERISTICS (Note 3)						
DC Current Gain (V_{CE} = 10 V, I_C = 5.0 mA)	NSBC114EPDXV6T1	h_{FE}	35	60	−	
	NSBC124EPDXV6T1		60	100	−	
	NSBC144EPDXV6T1		80	140	−	
	NSBC114YPDXV6T1		80	140	−	
	NSBC114TPDXV6T1		160	350	−	
	NSBC143TPDXV6T1		160	350	−	
	NSBC113EPDXV6T1		3.0	5.0	−	
	NSBC123EPDXV6T1		8.0	15	−	
	NSBC143EPDXV6T1		15	30	−	
	NSBC143ZPDXV6T1		80	200	−	
	NSBC124XPDXV6T1		80	150	−	
	NSBC123JPDXV6T1		80	140	−	
Collector-Emitter Saturation Voltage (I_C = 10 mA, I_B = 0.3 mA) (I_C = 10 mA, I_B = 5 mA) NSBC113EPDXV6T1/NSBC123EPDXV6T1 (I_C = 10 mA, I_B = 1 mA) NSBC114TPDXV6T1/NSBC143TPDXV6T1 NSBC143EPDXV6T1/NSBC143ZPDXV6T1/NSBC124XPDXV6T1		$V_{CE(sat)}$	−	−	0.25	Vdc

2. New resistor combinations. Updated curves to follow in subsequent data sheets.
3. Pulse Test: Pulse Width < 300 μs, Duty Cycle < 2.0%

ELECTRICAL CHARACTERISTICS

(T_A = 25°C unless otherwise noted, common for Q_1 and Q_2, − minus sign for Q_1 (PNP) omitted)

Characteristic		Symbol	Min	Typ	Max	Unit
ON CHARACTERISTICS (Note 3)						
Output Voltage (on)		V_{OL}				Vdc
(V_{CC} = 5.0 V, V_B = 2.5 V, R_L = 1.0 kΩ)	NSBC114EPDXV6T1		−	−	0.2	
	NSBC124EPDXV6T1		−	−	0.2	
	NSBC114YPDXV6T1		−	−	0.2	
	NSBC114TPDXV6T1		−	−	0.2	
	NSBC143TPDXV6T1		−	−	0.2	
	NSBC113EPDXV6T1		−	−	0.2	
	NSBC123EPDXV6T1		−	−	0.2	
	NSBC143EPDXV6T1		−	−	0.2	
	NSBC143ZPDXV6T1		−	−	0.2	
	NSBC124XPDXV6T1		−	−	0.2	
	NSBC123JPDXV6T1		−	−	0.2	
(V_{CC} = 5.0 V, V_B = 3.5 V, R_L = 1.0 kΩ)	NSBC144EPDXV6T1		−	−	0.2	
Output Voltage (off)		V_{OH}	4.9	−	−	Vdc
(V_{CC} = 5.0 V, V_B = 0.5 V, R_L = 1.0 kΩ)						
(V_{CC} = 5.0 V, V_B = 0.050 V, R_L = 1.0 kΩ)	NSBC113EPDXV6T1					
(V_{CC} = 5.0 V, V_B = 0.25 V, R_L = 1.0 kΩ)	NSBC114TPDXV6T1					
	NSBC143TPDXV6T1					
	NSBC143ZPDXV6T1					
Input Resistor	NSBC114EPDXV6T1	R1	7.0	10	13	k Ω
	NSBC124EPDXV6T1		15.4	22	28.6	
	NSBC144EPDXV6T1		32.9	47	61.1	
	NSBC114YPDXV6T1		7.0	10	13	
	NSBC114TPDXV6T1		7.0	10	13	
	NSBC143TPDXV6T1		3.3	4.7	6.1	
	NSBC113EPDXV6T1		0.7	1.0	1.3	
	NSBC123EPDXV6T1		1.5	2.2	2.9	
	NSBC143EPDXV6T1		3.3	4.7	6.1	
	NSBC143ZPDXV6T1		3.3	4.7	6.1	
	NSBC124XPDXV6T1		15.4	22	28.6	
	NSBC123JPDXV6T1		1.54	2.2	2.86	
Resistor Ratio		R1/R2	0.8	1.0	1.2	
NSBC114EPDXV6T1/NSBC124EPDXV6T1/NSBC144EPDXV6T1			0.17	0.21	0.25	
NSBC114YPDXV6T1			−	−	−	
NSBC114TPDXV6T1/NSBC143TPDXV6T1			0.8	1.0	1.2	
NSBC113EPDXV6T1/NSBC123EPDXV6T1/NSBC143EPDXV6T1			0.055	0.1	0.185	
NSBC143ZPDXV6T1			0.38	0.47	0.56	
NSBC124XPDXV6T1			0.038	0.047	0.056	
NSBC123JPDXV6T1						

2. New resistor combinations. Updated curves to follow in subsequent data sheets.
3. Pulse Test: Pulse Width < 300 μs, Duty Cycle < 2.0%

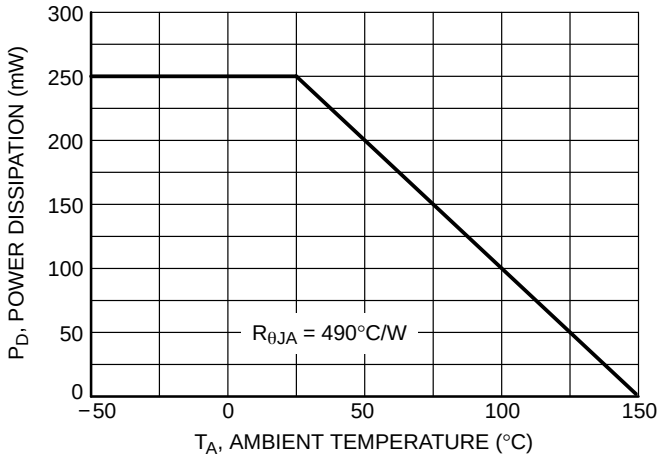


Figure 1. Derating Curve

TYPICAL ELECTRICAL CHARACTERISTICS − NSBC114EPDXV6T1 NPN TRANSISTOR

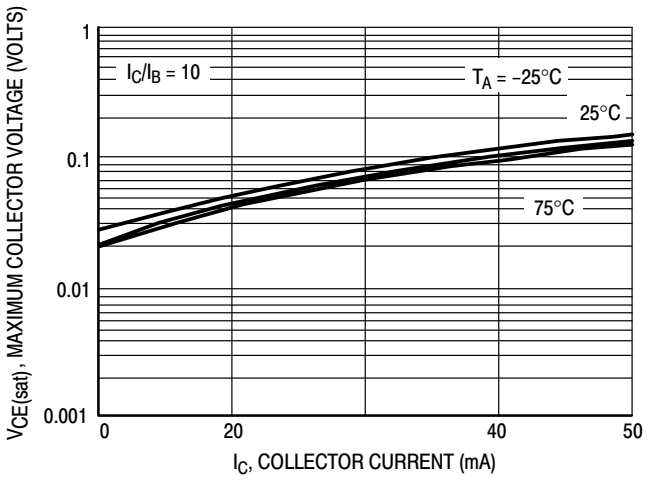


Figure 2. $V_{CE(sat)}$ versus I_C

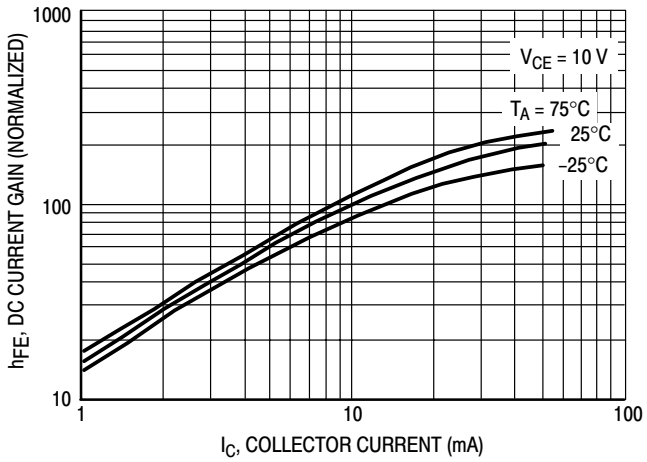


Figure 3. DC Current Gain

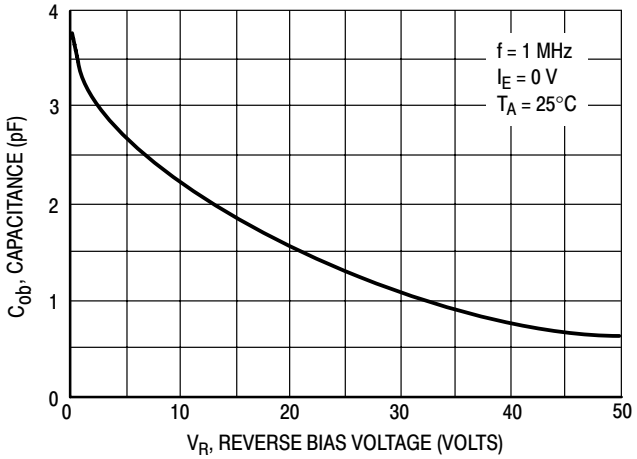


Figure 4. Output Capacitance

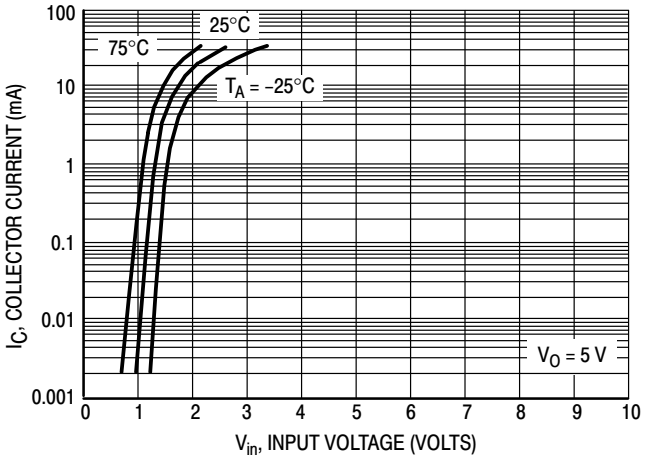


Figure 5. Output Current versus Input Voltage

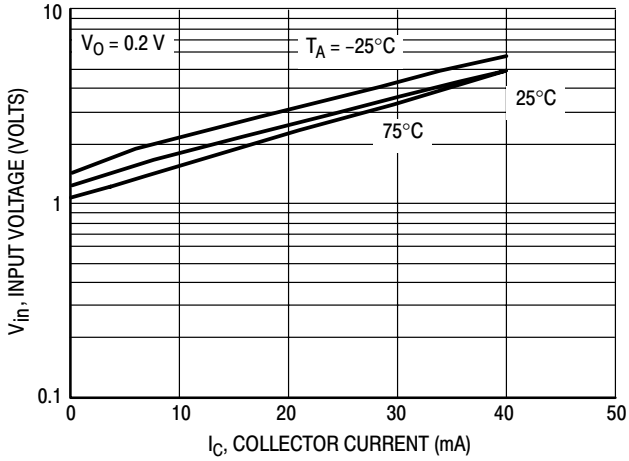


Figure 6. Input Voltage versus Output Current

TYPICAL ELECTRICAL CHARACTERISTICS − NSBC114EPDXV6T1 PNP TRANSISTOR

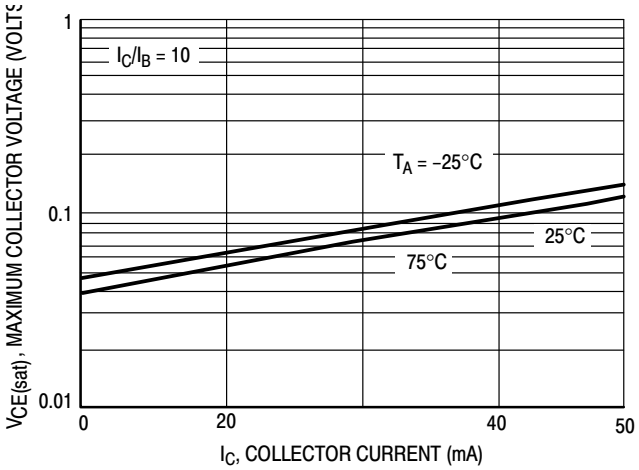


Figure 7. $V_{CE(sat)}$ versus I_C

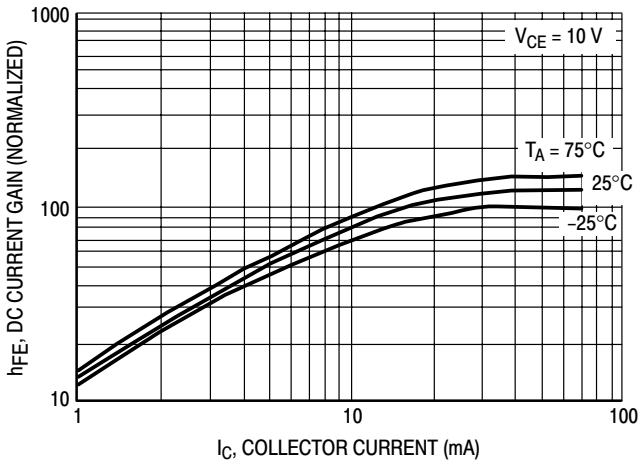


Figure 8. DC Current Gain

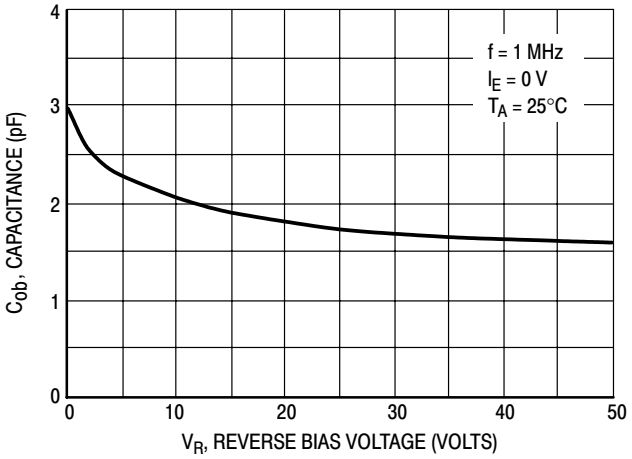


Figure 9. Output Capacitance

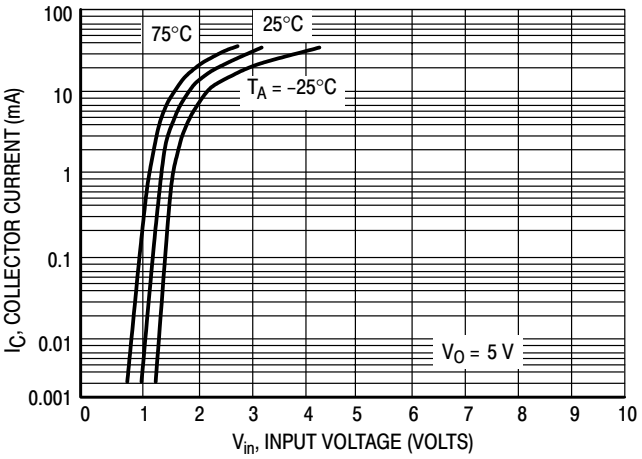


Figure 10. Output Current versus Input Voltage

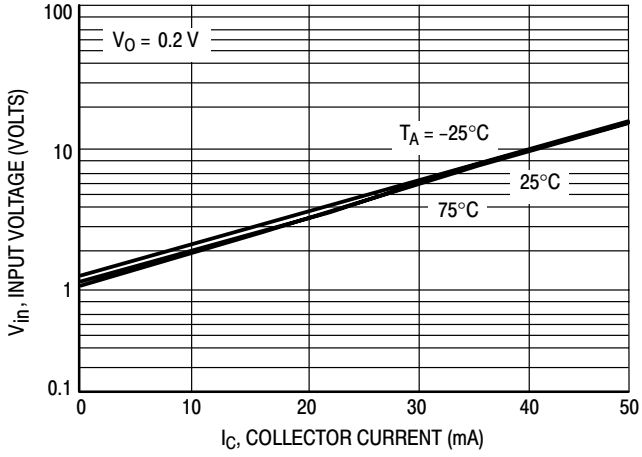


Figure 11. Input Voltage versus Output Current

TYPICAL ELECTRICAL CHARACTERISTICS − NSBC124EPDXV6T1 NPN TRANSISTOR

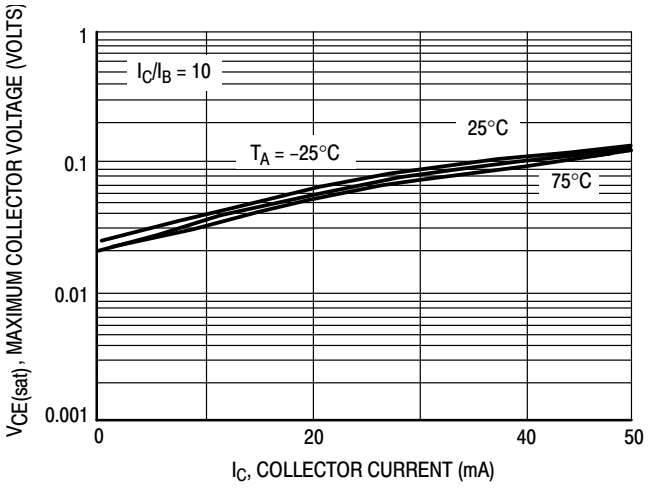


Figure 12. $V_{CE(sat)}$ versus I_C

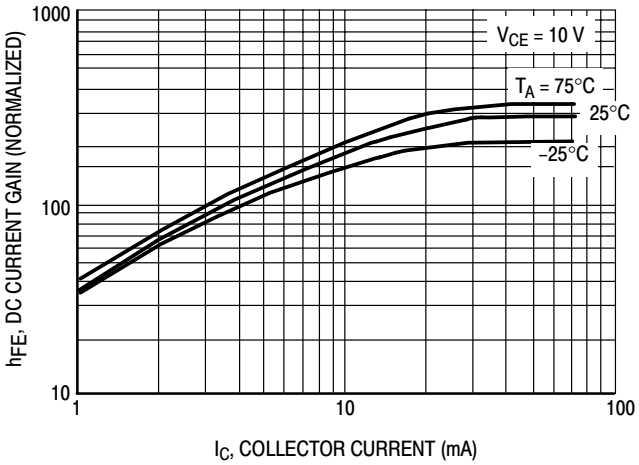


Figure 13. DC Current Gain

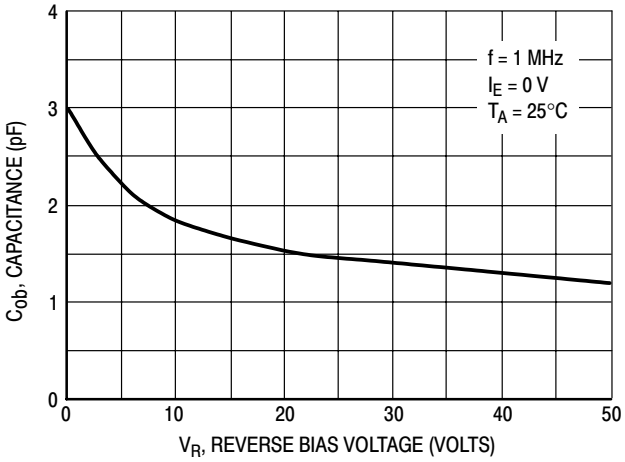


Figure 14. Output Capacitance

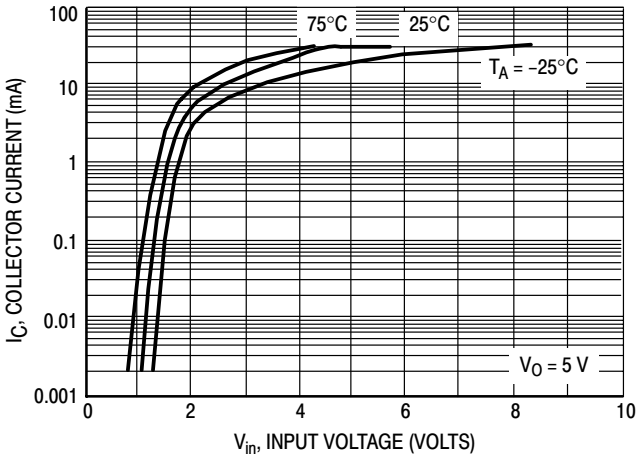


Figure 15. Output Current versus Input Voltage

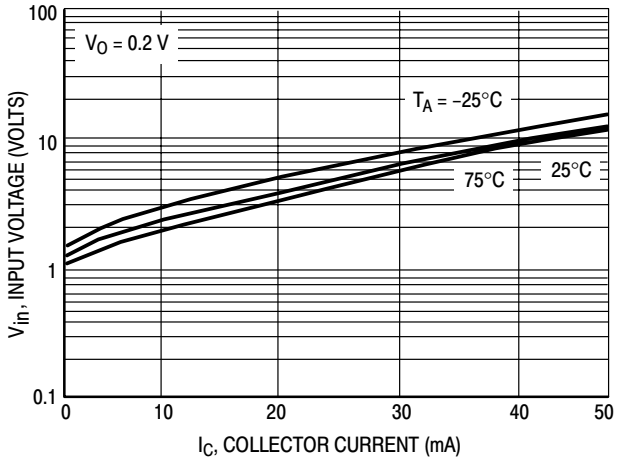


Figure 16. Input Voltage versus Output Current

TYPICAL ELECTRICAL CHARACTERISTICS − NSBC124EPDXV6T1 PNP TRANSISTOR

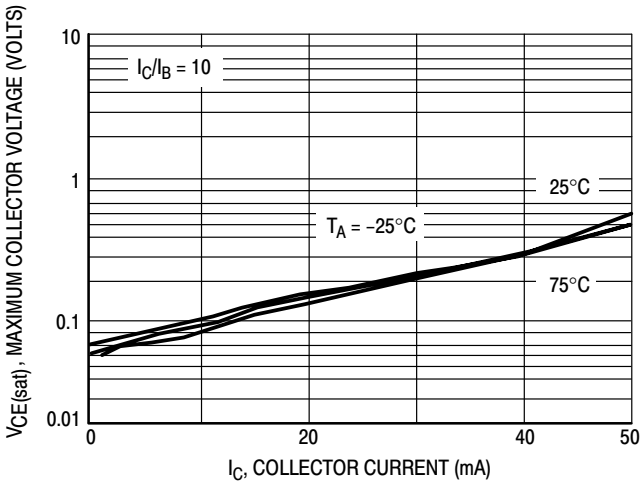


Figure 17. $V_{CE(sat)}$ versus I_C

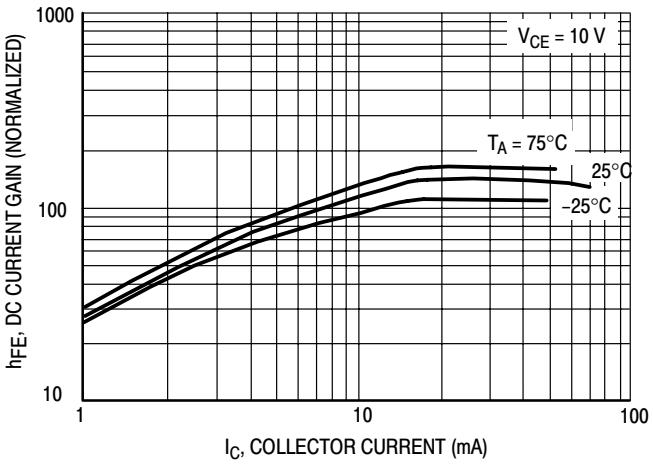


Figure 18. DC Current Gain

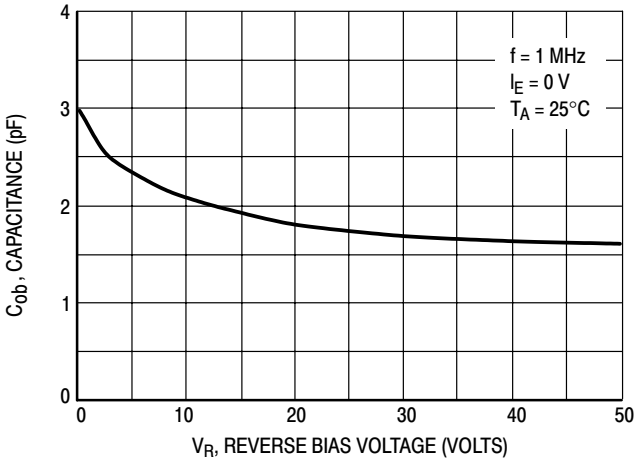


Figure 19. Output Capacitance

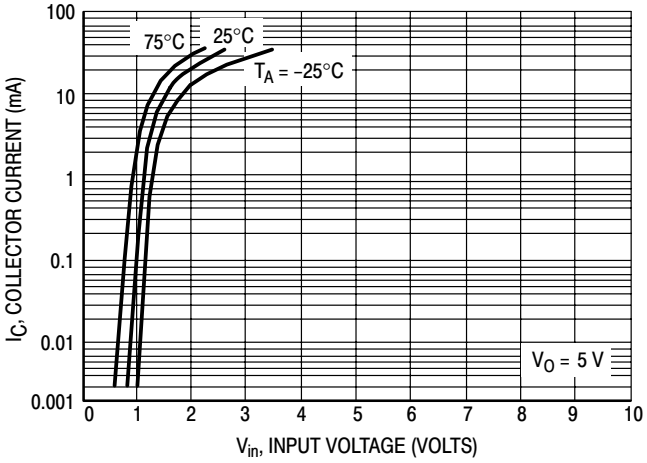


Figure 20. Output Current versus Input Voltage

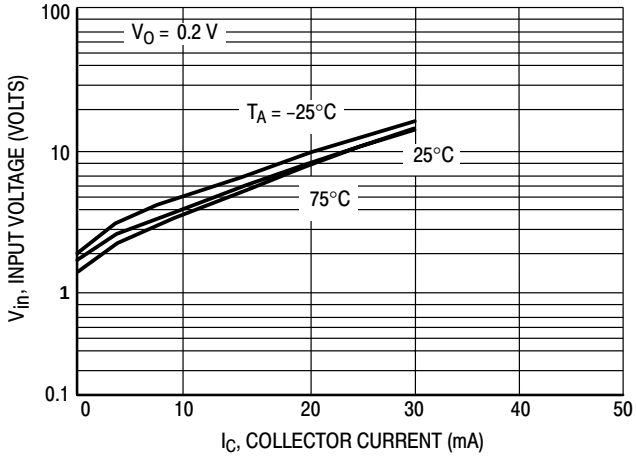


Figure 21. Input Voltage versus Output Current

TYPICAL ELECTRICAL CHARACTERISTICS − NSBC144EPDXV6T1 NPN TRANSISTOR

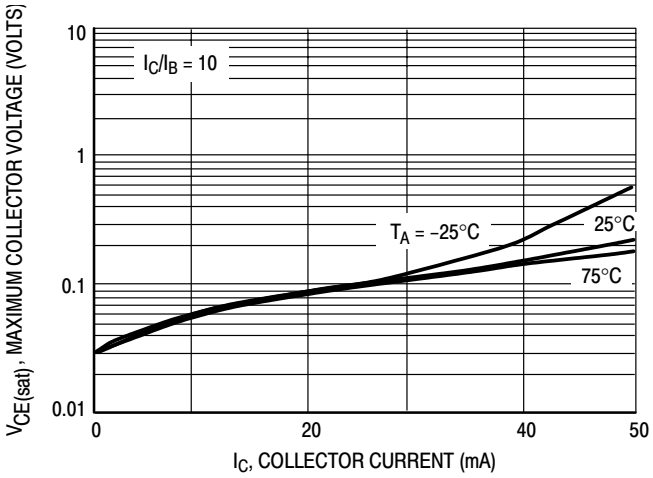


Figure 22. $V_{CE(sat)}$ versus I_C

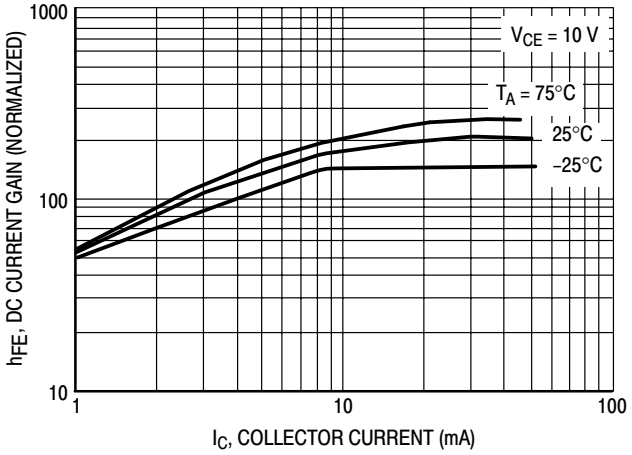


Figure 23. DC Current Gain

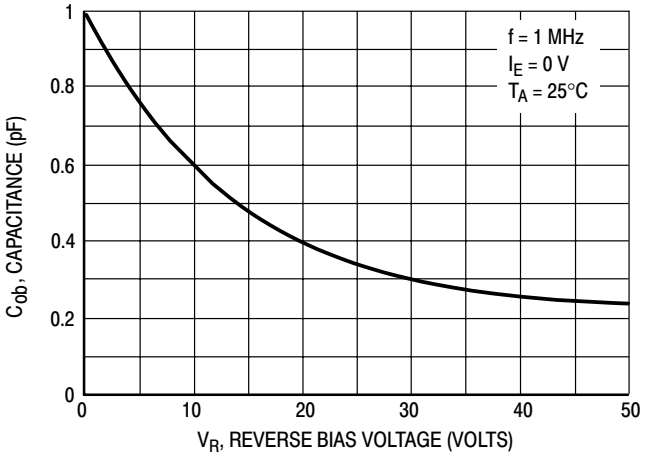


Figure 24. Output Capacitance

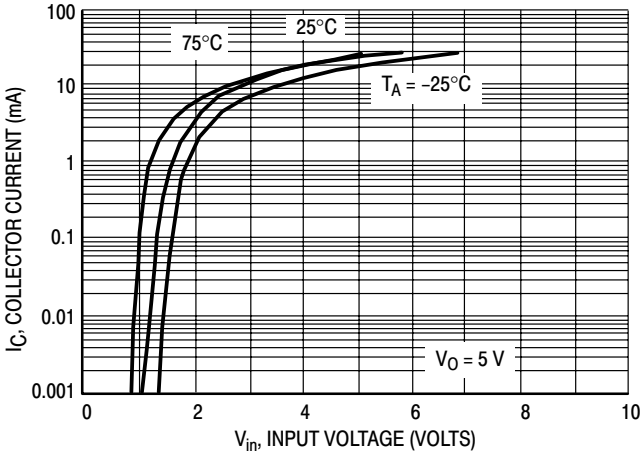


Figure 25. Output Current versus Input Voltage

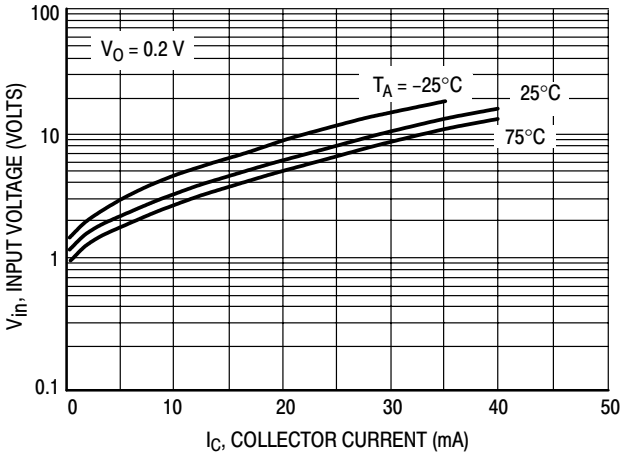


Figure 26. Input Voltage versus Output Current

TYPICAL ELECTRICAL CHARACTERISTICS − NSBC144EPDXV6T1 PNP TRANSISTOR

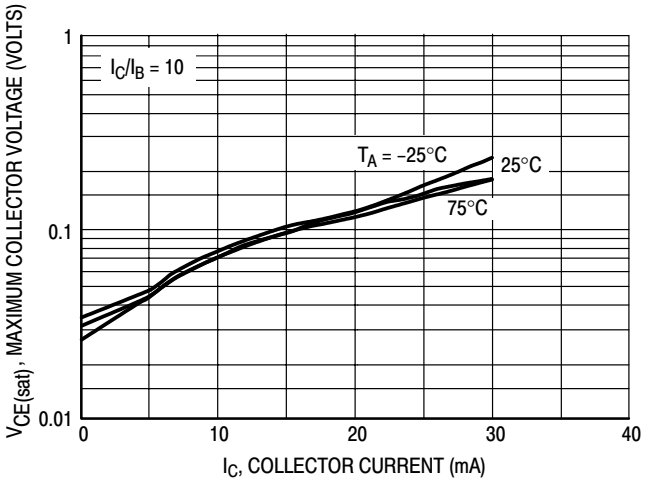


Figure 27. $V_{CE(sat)}$ versus I_C

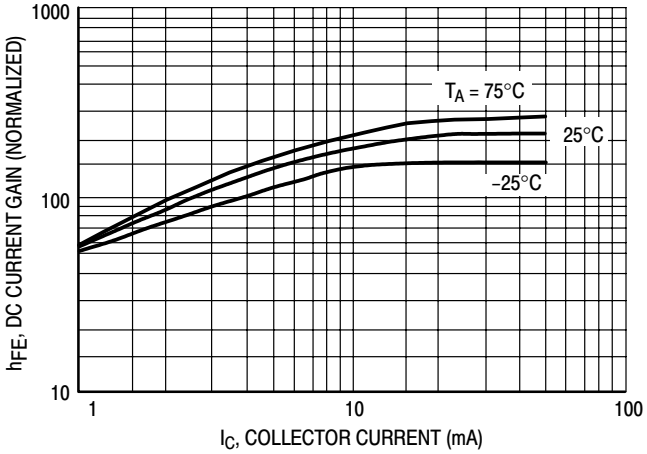


Figure 28. DC Current Gain

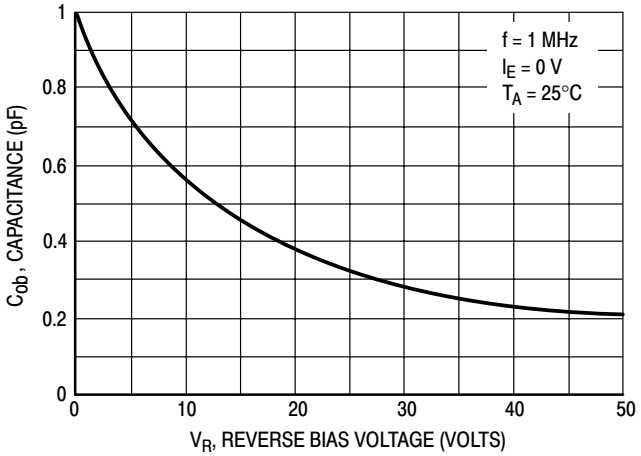


Figure 29. Output Capacitance

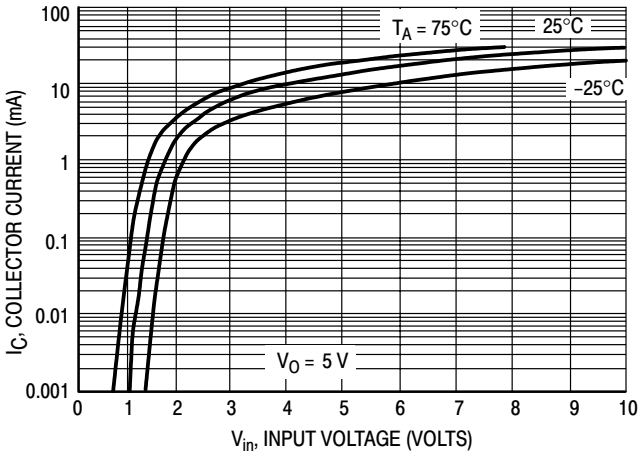


Figure 30. Output Current versus Input Voltage

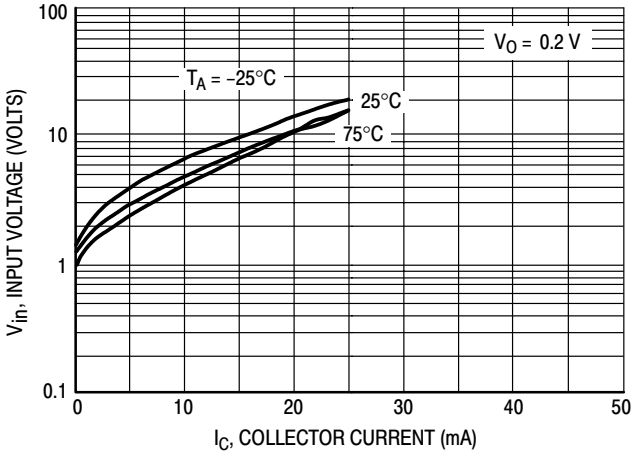


Figure 31. Input Voltage versus Output Current

TYPICAL ELECTRICAL CHARACTERISTICS − NSBC114YPDXV6T1 NPN TRANSISTOR

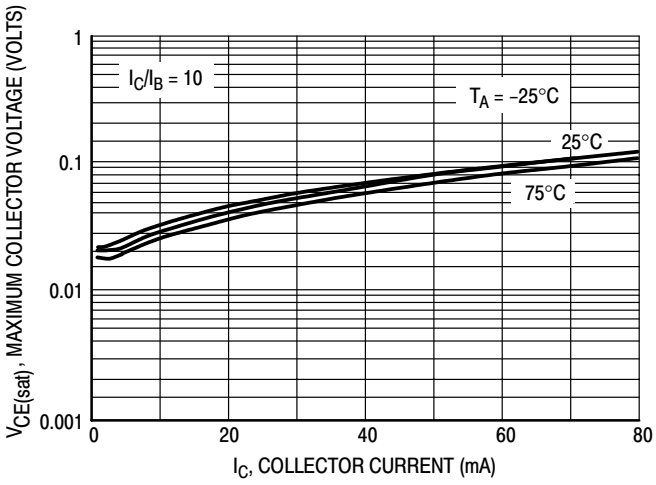


Figure 32. $V_{CE(sat)}$ versus I_C

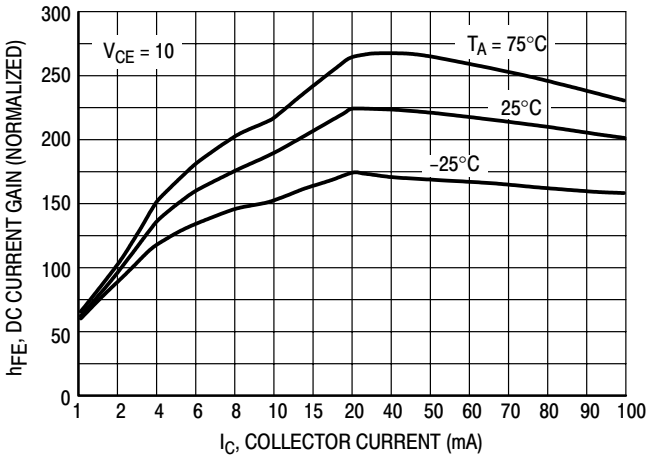


Figure 33. DC Current Gain

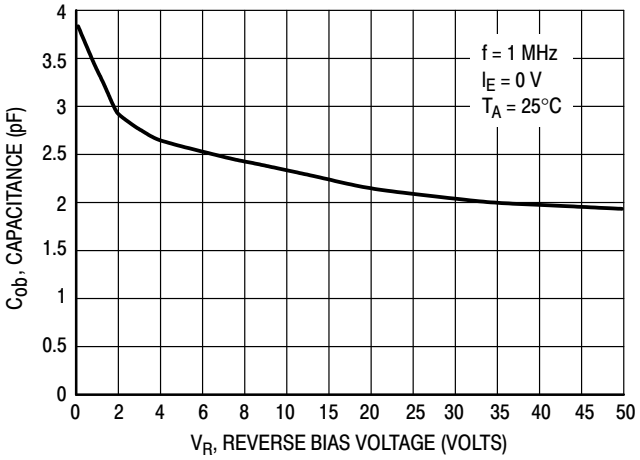


Figure 34. Output Capacitance

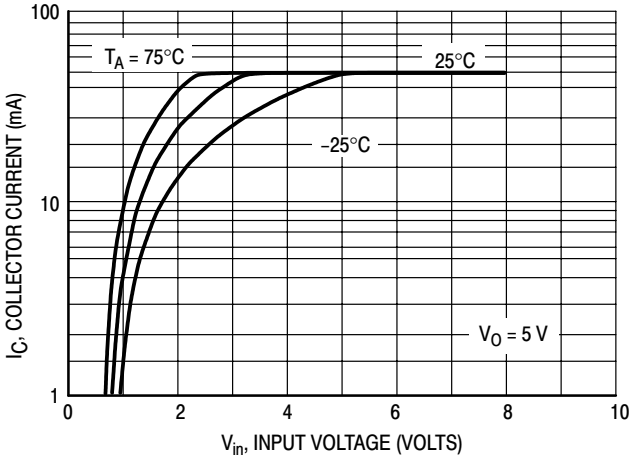


Figure 35. Output Current versus Input Voltage

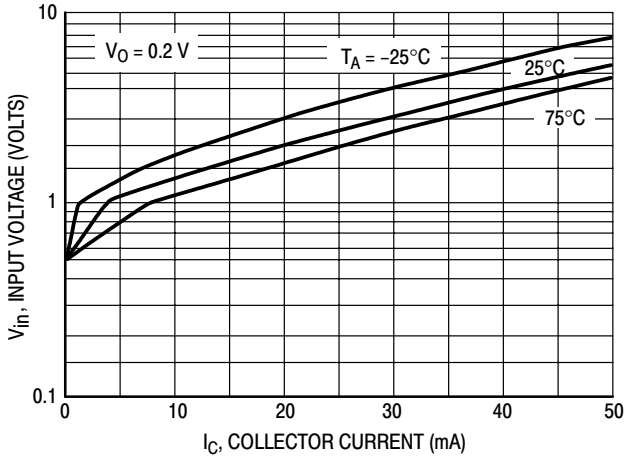


Figure 36. Input Voltage versus Output Current

TYPICAL ELECTRICAL CHARACTERISTICS − NSBC114YPDXV6T1 PNP TRANSISTOR

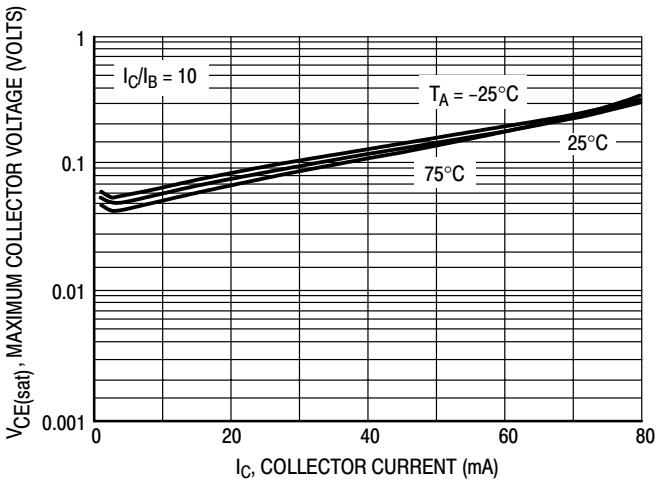


Figure 37. $V_{CE(sat)}$ versus I_C

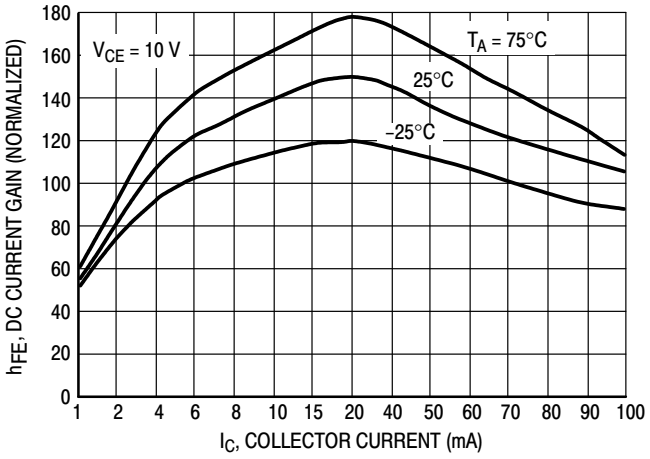


Figure 38. DC Current Gain

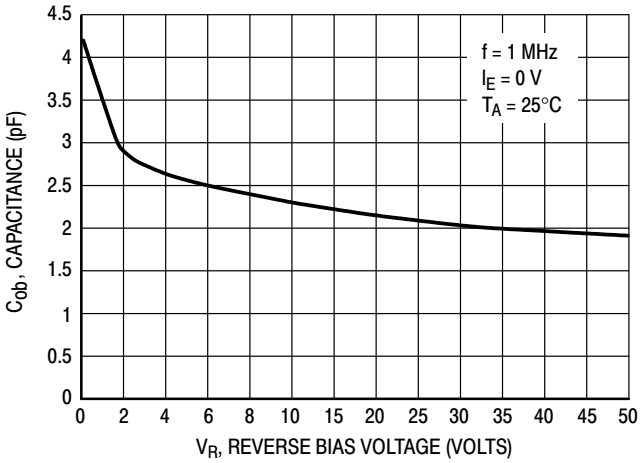


Figure 39. Output Capacitance

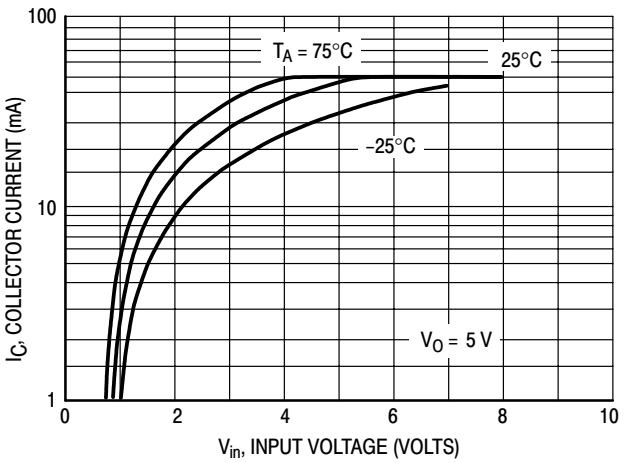


Figure 40. Output Current versus Input Voltage

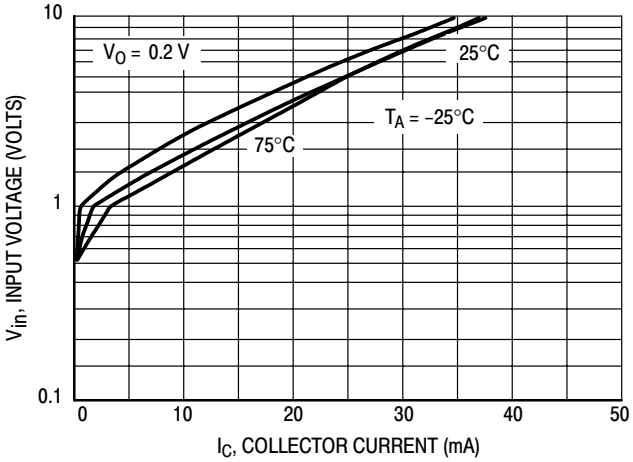


Figure 41. Input Voltage versus Output Current

TYPICAL ELECTRICAL CHARACTERISTICS − NSBC114TPDXV6T1

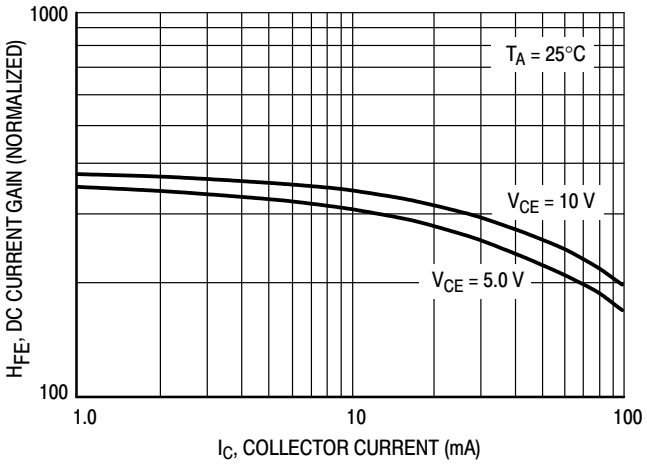


Figure 42. DC Current Gain − PNP

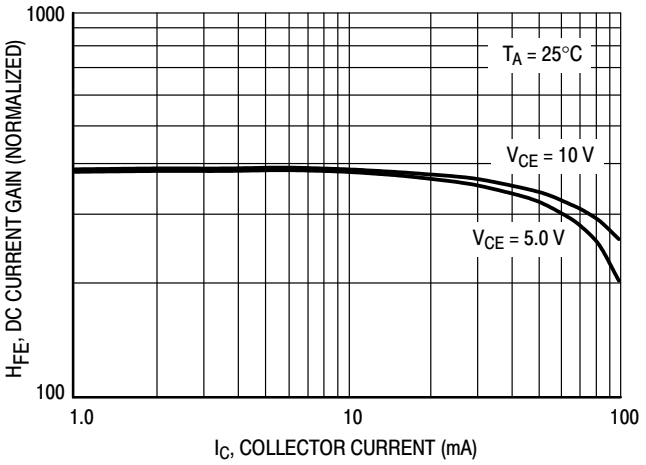


Figure 43. DC Current Gain − NPN

TYPICAL ELECTRICAL CHARACTERISTICS − NSBC143TPDXV6T1

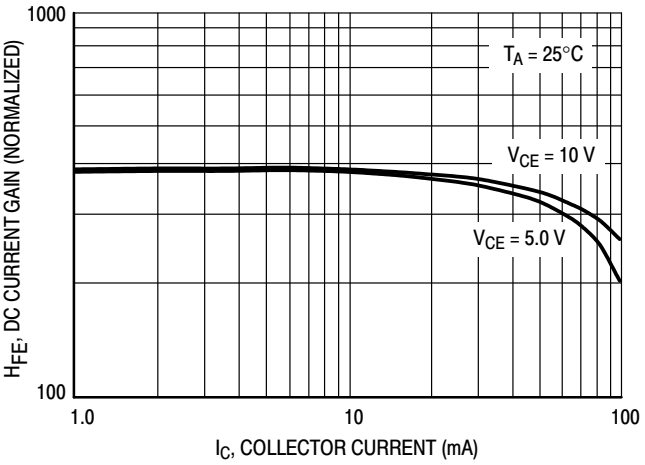


Figure 44. DC Current Gain − PNP

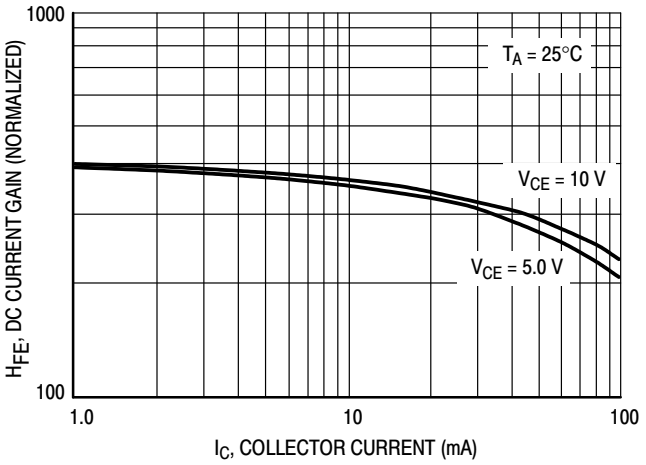
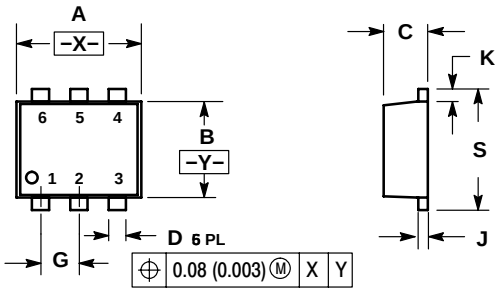


Figure 45. DC Current Gain − NPN

PACKAGE DIMENSIONS

SOT−563, 6 LEAD
CASE 463A−01
ISSUE O



NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETERS
3. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF BASE MATERIAL.

	MILLIMETERS		INCHES	
DIM	MIN	MAX	MIN	MAX
A	1.50	1.70	0.059	0.067
B	1.10	1.30	0.043	0.051
C	0.50	0.60	0.020	0.024
D	0.17	0.27	0.007	0.011
G	0.50 BSC		0.020 BSC	
J	0.08	0.18	0.003	0.007
K	0.10	0.30	0.004	0.012
S	1.50	1.70	0.059	0.067

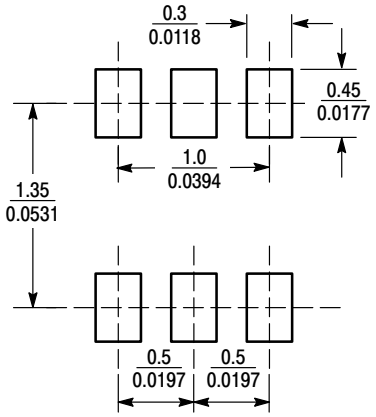
STYLE 1:
PIN 1. EMITTER 1
2. BASE 1
3. COLLECTOR 2
4. EMITTER 2
5. BASE 2
6. COLLECTOR 1

STYLE 2:
PIN 1. EMITTER 1
2. EMITTER2
3. BASE 2
4. COLLECTOR 2
5. BASE 1
6. COLLECTOR 1

STYLE 3:
PIN 1. CATHODE 1
2. CATHODE 1
3. ANODE/ANODE 2
4. CATHODE 2
5. CATHODE 2
6. ANODE/ANODE 1

STYLE 4:
PIN 1. COLLECTOR
2. COLLECTOR
3. BASE
4. EMITTER
5. COLLECTOR
6. COLLECTOR

SOLDERING FOOTPRINT*



SCALE 20:1 $\left(\frac{\text{mm}}{\text{inches}}\right)$

*For additional information on our Pb−Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:
Literature Distribution Center for ON Semiconductor
P.O. Box 5163, Denver, Colorado 80217 USA
Phone: 303−675−2175 or 800−344−3860 Toll Free USA/Canada
Fax: 303−675−2176 or 800−344−3867 Toll Free USA/Canada
Email: orderlit@onsemi.com

N. American Technical Support: 800−282−9855 Toll Free USA/Canada

Japan: ON Semiconductor, Japan Customer Focus Center
2−9−1 Kamimeguro, Meguro−ku, Tokyo, Japan 153−0051
Phone: 81−3−5773−3850

ON Semiconductor Website: http://onsemi.com

Order Literature: http://www.onsemi.com/litorder

For additional information, please contact your local Sales Representative.